

## HOSTAFORM® XGC25 XAP® ECO-C 672 HOSTAFORM®

Hostaform® XGC25 XAP® ECO-C 672 is an acetal copolymer reinforced with approximately 25% glass fibers. Compared to the Hostaform® C 9021 GV 1/30, Hostaform® XGC25 XAP® has a higher strength and lower emissions.

ISO 29988-POM-K,(GF25),EM,0-3

ECO-C: Hostaform® POM XGC25 XAP® ECO-C 672 incorporates circular content derived from captured carbon dioxide emissions in the finished product through mass balance allocation. The product is a drop-in replacement to the standard grade with the same performance and processing properties and contributes to the displacement of virgin fossil fuel resources. The feedstock utilizing captured carbon dioxide emissions are ISCC CFC certified as low carbon intensity methanol.

### Product information

Resin Identification	POM-GF25	ISO 1043
Part Marking Code	>POM-GF25<	ISO 11469

### Rheological properties

Melt volume-flow rate	2 cm <sup>3</sup> /10min	ISO 1133
Temperature	190 °C	
Load	2.16 kg	
Moulding shrinkage, parallel	0.6 %	ISO 294-4, 2577
Moulding shrinkage, normal	1.0 %	ISO 294-4, 2577

### Typical mechanical properties

Tensile modulus	9000 MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	155 MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	3.5 %	ISO 527-1/-2
Flexural modulus	8300 MPa	ISO 178
Compressive stress at 1% strain	85 MPa	ISO 604
Charpy impact strength, 23 °C	70 kJ/m <sup>2</sup>	ISO 179/1eU
Charpy notched impact strength, 23 °C	13 kJ/m <sup>2</sup>	ISO 179/1eA
Charpy notched impact strength, -30 °C	11 kJ/m <sup>2</sup>	ISO 179/1eA
Hardness, Rockwell, M-scale	96	ISO 2039-2
Poisson's ratio	0.34 <sup>[C]</sup>	

[C]: Calculated

### Thermal properties

Melting temperature, 10 °C/min	166 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	160 °C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	166 °C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	30 E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	60 E-6/K	ISO 11359-1/-2

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### Physical/Other properties

Water absorption, 2mm	0.9 %	Sim. to ISO 62
Density	1580 kg/m <sup>3</sup>	ISO 1183

### Injection

Drying Recommended	no
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	3 - 4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	200 °C
Min. melt temperature	190 °C
Max. melt temperature	210 °C
Screw tangential speed	≤0.3 m/s
Mold Temperature Optimum	100 °C
Min. mould temperature	80 °C
Max. mould temperature	120 °C
Hold pressure range	60 - 120 MPa
Back pressure	2 MPa
Ejection temperature	137 °C

### Characteristics

Processing	Injection Moulding
Special characteristics	Low emissions
Sustainability	Carbon Capture

### Additional information

#### Processing Notes

#### Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

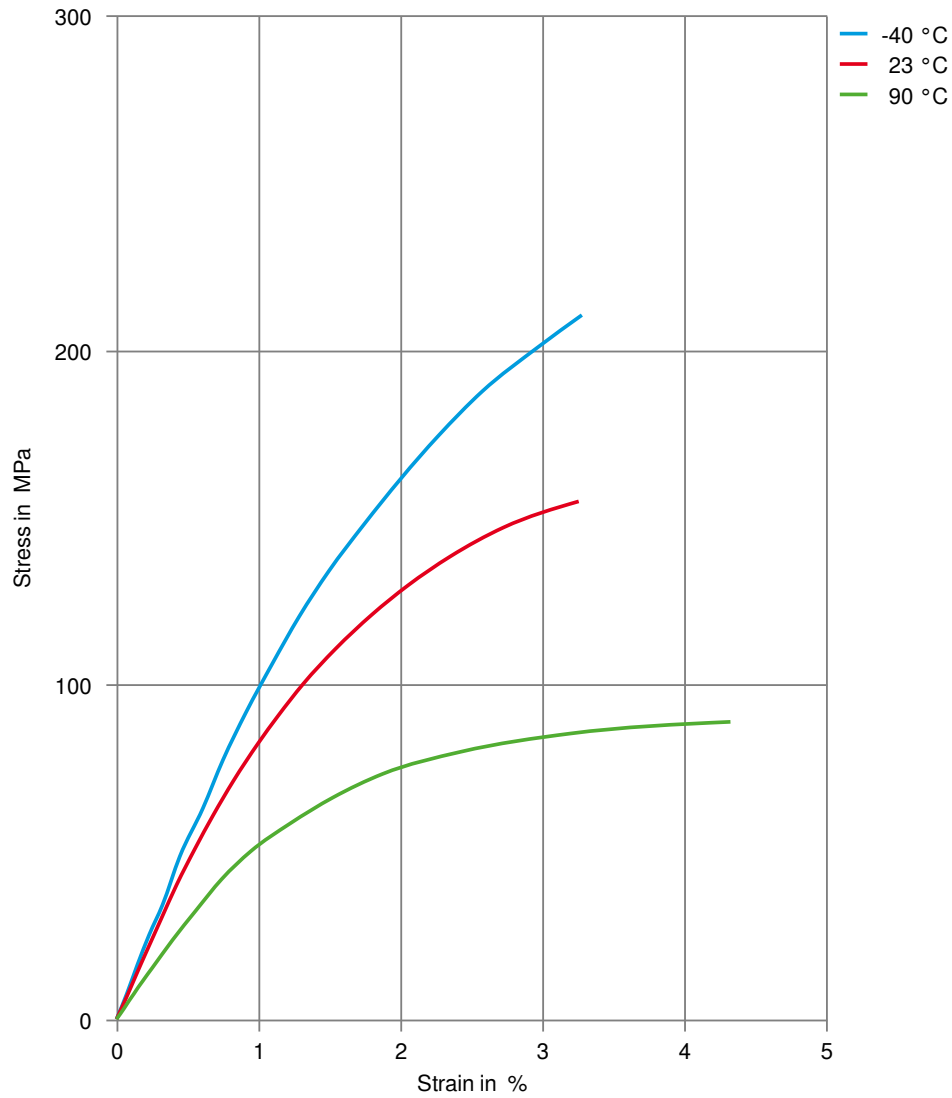
#### Storage

The product can then be stored in standard conditions until processed.

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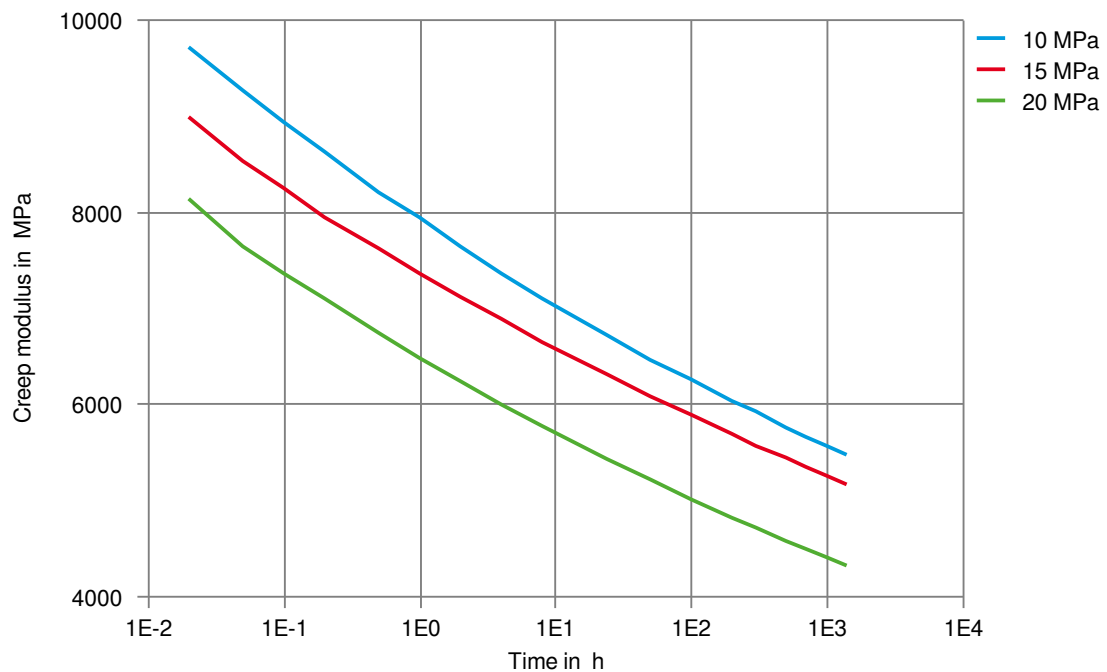
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### Stress-strain



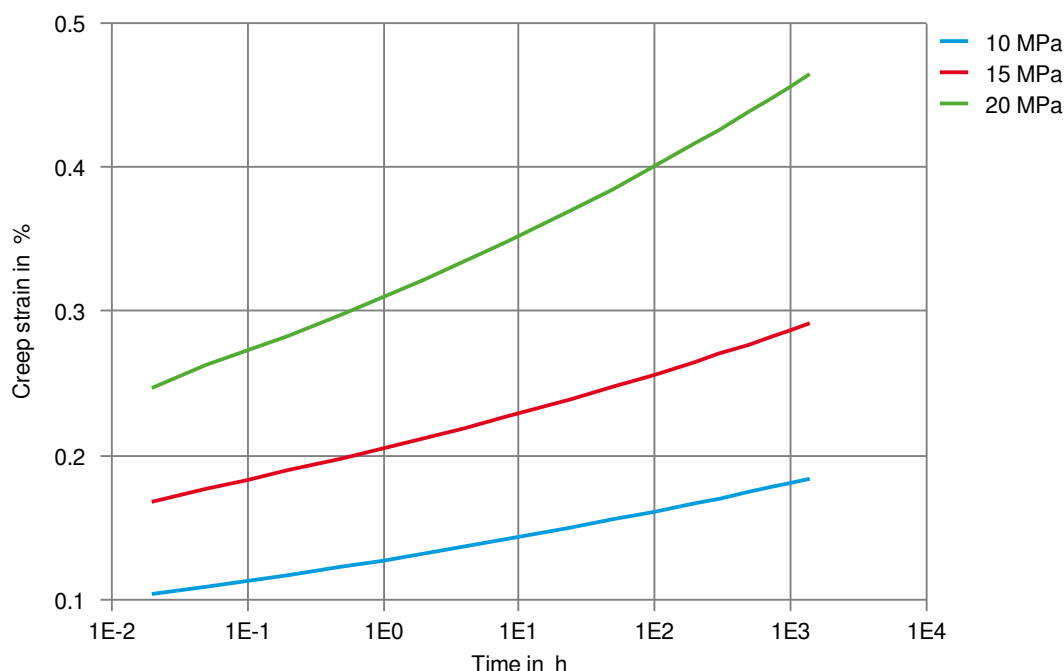
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Creep modulus-time 90°C



# HOSTAFORM® XGC25 XAP® ECO-C 672 HOSTAFORM®

## Creep strain-time 90 °C



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